

Datasheet ISC-nRF52810-A

Multiprotocol BLE, ANT, 2.4GHz module

V0.2



Table of Contents

| 1. | General Description | 3 |
|----|------------------------------------|----|
| 2. | Features | 4 |
| 3. | Applications | 7 |
| 4. | Application Block Diagram | 8 |
| 5. | Interfaces | 9 |
| | Power Supply | 9 |
| | System Function Interfaces | |
| | GPIOs | |
| | Two-wire Interface(I2CCompatible) | 10 |
| | Flash Program I/Os | |
| | Serial Peripheral Interface | 10 |
| | UARTs | 11 |
| | Analogue to Digital Converter(ADC) | 12 |
| | Reset | 12 |
| 6. | Module Specifications | 13 |
| 7. | Module Pin-out and Pin Description | 14 |
| | Module Pin-out | |
| | Pin Footprint | 14 |
| | Pin Description | 14 |
| 8. | Electrical Characteristics | 16 |
| | Absolute Maximum Ratings | 16 |
| | Recommended Operating Ratings | 16 |
| | Current Ratings | 17 |
| 9. | Ordering Information | 18 |



1. General Description

The module ISC_nRF52810_A is a powerful, highly flexible, ultra-low power Bluetooth Low Energy module using Nordic nRF52810 SoC solution developed by Indiesemic. This module supports BLE 5.3 standards. With an ARM Cortex M4 Processor available, it provides192kB Flash, 24kBRAM, embedded 2.4GHz multiprotocol transceiver and an integrated PCB trace antenna.

The module incorporates: GPIO, SPI, UART, I2C, I2S, PMD, PWM, ADC interfaces for connecting peripherals and sensors.





2. Features

| Bluetooth ®low energy mode Supported data rates: 1 Mbps, 2 Mbps Bluetooth® low energy mode -20 to +4dBm TX power, Configurable in 4dBsteps On-chip balun (single-ended RF) 4.6mA peak current in TX(0 dBm) 4.6mA peak current in RX RSSI(1 dB resolution) -144 EEMBC Core Mark® score running from flash memory 34.4µA/MHz running from Flash memory 32.8µA/MHz running from RAM Serial wire debug(SWD) 1.7 V-3.6 V supply voltage range Flexible power management Flexip automatic LDO and DC/DC regulator system | | • -96 dBm sensitivity in |
|---|---------------------------|--|
| 2 Mbps Bluetooth® low energy mode 20 to +4dBm TX power, Configurable in 4dBsteps - On-chip balun (single-ended RF) - 4.6mA peak current in TX(0 dBm) - 4.6mA peak current in RX - RSSI(1 dB resolution) - 144 EEMBC Core Mark® score running from flash memory - 34.4µA/MHz running from Flash memory - 32.8µA/MHz running from RAM - Serial wire debug(SWD) - 1.7 V-3.6 V supply voltage range - Fully automatic LDO and DC/DC | | Bluetooth ®low energy mode |
| mode 20 to +4dBm TX power, Configurable in 4dBsteps - On-chip balun (single-ended RF) - 4.6mA peak current in TX(0 dBm) - 4.6mA peak current in RX - RSSI(1 dB resolution) - 144 EEMBC Core Mark® score running from flash memory - 34.4µA/MHz running from Flash memory - 32.8µA/MHz running from RAM - Serial wire debug(SWD) - 1.7 V-3.6 V supply voltage range - Fully automatic LDO and DC/DC | | Supported data rates: 1 Mbps, |
| 2.4GHz transceiver • -20 to +4dBm TX power, Configurable in 4dBsteps • On-chip balun (single-ended RF) • 4.6mA peak current in TX(0 dBm) • 4.6mA peak current in RX • RSSI(1 dB resolution) • 144 EEMBC Core Mark® score running from flash memory • 34.4µA/MHz running from Flash memory • 32.8µA/MHz running from RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range • Fully automatic LDO and DC/DC | | 2 Mbps Bluetooth® low energy |
| 2.4GHz transceiver Configurable in 4dBsteps On-chip balun (single-ended RF) 4.6mA peak current in TX(0 dBm) 4.6mA peak current in RX RSSI(1 dB resolution) 144 EEMBC Core Mark® score running from flash memory 32.8µA/MHz running from Flash memory 132.8µA/MHz running from RAM Serial wire debug(SWD) 1.7 V-3.6 V supply voltage range Flexible power management Fully automatic LDO and DC/DC | | mode |
| On-chip balun (single-ended RF) 4.6mA peak current in TX(0 dBm) 4.6mA peak current in RX RSSI(1 dB resolution) 144 EEMBC Core Mark® score running from flash memory 34.4µA/MHz running from Flash memory 32.8µA/MHz running from RAM Serial wire debug(SWD) 1.7 V-3.6 V supply voltage range Flexible power management Fully automatic LDO and DC/DC | | • -20 to +4dBm TX power, |
| RF) • 4.6mA peak current in TX(0 dBm) • 4.6mA peak current in RX • RSSI(1 dB resolution) • 144 EEMBC Core Mark® score running from flash memory • 34.4μA/MHz running from Flash memory • 32.8μA/MHz running from RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range • Fully automatic LDO and DC/DC | 2.4GHz transceiver | Configurable in 4dBsteps |
| 4.6mA peak current in TX(0 dBm) 4.6mA peak current in RX RSSI(1 dB resolution) 144 EEMBC Core Mark® score running from flash memory 34.4μA/MHz running from Flash memory 32.8μA/MHz running from RAM Serial wire debug(SWD) 1.7 V-3.6 V supply voltage range Fully automatic LDO and DC/DC | | On-chip balun (single-ended |
| dBm) 4.6mA peak current in RX RSSI(1 dB resolution) 144 EEMBC Core Mark® score running from flash memory 34.4μA/MHz running from Flash memory 132.8μA/MHz running from RAM Serial wire debug(SWD) 1.7 V-3.6 V supply voltage range Flexible power management Fully automatic LDO and DC/DC | | RF) |
| 4.6mA peak current in RX RSSI(1 dB resolution) 144 EEMBC Core Mark® score running from flash memory 34.4μA/MHz running from Flash memory 32.8μA/MHz running from RAM Serial wire debug(SWD) 1.7 V-3.6 V supply voltage range Fully automatic LDO and DC/DC | | 4.6mA peak current in TX(0 |
| • RSSI(1 dB resolution) • 144 EEMBC Core Mark® score running from flash memory • 34.4µA/MHz running from Flash memory • 32.8µA/MHz running from RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range • Fully automatic LDO and DC/DC | | dBm) |
| • 144 EEMBC Core Mark® score running from flash memory • 34.4µA/MHz running from Flash memory • 32.8µA/MHz running from RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range • Fully automatic LDO and DC/DC | | 4.6mA peak current in RX |
| score running from flash memory • 34.4μA/MHz running from Flash memory • 32.8μA/MHz running from RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range • Fully automatic LDO and DC/DC | | RSSI(1 dB resolution) |
| score running from flash memory • 34.4μA/MHz running from Flash memory • 32.8μA/MHz running from RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range • Fully automatic LDO and DC/DC | | 1// FEMBC Core Mark® |
| memory • 34.4μA/MHz running from Flash memory • 32.8μA/MHz running from RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range • Fully automatic LDO and DC/DC | | |
| ARM® Cortex®-M4 32-bit 34.4μA/MHz running from Flash memory 32.8μA/MHz running from RAM Serial wire debug(SWD) 1.7 V-3.6 V supply voltage range Fully automatic LDO and DC/DC | | |
| Flash memory • 32.8µA/MHz running from RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range Flexible power management • Fully automatic LDO and DC/DC | ARM® Cortex®-M4 32-bit | • |
| • 32.8µA/MHz running from RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range Flexible power management • Fully automatic LDO and DC/DC | processor,64MHz | · |
| RAM • Serial wire debug(SWD) • 1.7 V-3.6 V supply voltage range • Fully automatic LDO and DC/DC | | , |
| • 1.7 V-3.6 V supply voltage range Flexible power management • Fully automatic LDO and DC/DC | | |
| voltage range Flexible power management • Fully automatic LDO and DC/DC | | Serial wire debug(SWD) |
| Flexible power management • Fully automatic LDO and DC/DC | | • 1.7 V-3.6 V supply |
| Fully automatic LDO and DC/DC | Planible name management | voltage range |
| regulator system | riexible power management | Fully automatic LDO and DC/DC |
| · · · · · · · · · · · · · · · · · · · | | regulator system |



| | Fast wake-up using 64 |
|----------------|---|
| | MHz internal oscillator |
| | 0.3μA at 3V in System OFF |
| | mode, no RAM retention |
| | 0.5μA at 3Vin System OFF |
| | mode with full 24 kB RAM |
| | retention |
| | 1.5μA at 3V in System ON |
| | mode, with full 24 kB RAM |
| | retention |
| | 192kBflash/24kBRAM |
| Memory | |
| | Microprocessor Control Unit |
| | (MCU): nRF52810 |
| | Nordic Soft Device ready |
| | Support for concurrent |
| | multi-protocol |
| | • 12-bit,200kSPSADC-8 |
| | configurable channels with |
| Other features | programmable gain |
| | 64 level Comparator |
| | Temperature sensor |
| | Up to 15 general purpose |
| | I/O pins |
| | 4-channel pulse width |
| | modulator(PWM) unit with |
| | Easy DMA |
| | _ |



- Digital microphone interface (PDM)
- 3x32-bit timer with counter mode
- SPI master/slave with Easy DMA
- I2C compatible 2-wire master/slave
- UART(CTS/RTS) with Easy DMA
- Programmable peripheral interconnect (PPI)
- Quadrature decoder(QDEC)
- AESHW encryption with Easy DMA
- 2xreal-timecounter(RTC)



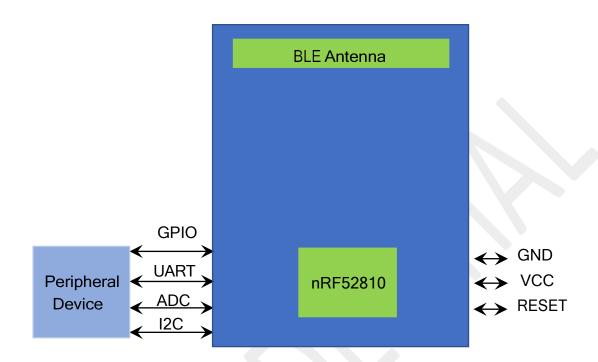
3. Applications

Due to varied support of protocols and stacks, the BLE module nRF52810 can support varied applications. A brief of the applications is as below:

| Internet of Things | Smart home productsIndustrial mesh networksSmart city infrastructure |
|-----------------------------------|---|
| Advanced Wearables | Connected watches Advanced personal fitness devices Wearables with wireless payment Connected health Virtual/Augmented reality applications |
| Interactive Entertainment Devices | Advanced remote controlsGaming controller |
| Personal Area Networks | Health/Fitness sensor and monitor device Medical device |



4. Application Block Diagram





5. Interfaces

Power Supply

The input voltage Vcc range should be1.7V to 3.6V. Suitable decoupling must be provided by external decoupling circuitry (10 uF and 0.1 uF). It can reduce the noise from power supply and increase power stability.

System Function Interfaces

GPIOs

The general purpose I/O is organized as one port with up to 16 I/Os enabling access and control of up to 16 pins through one port. Each GPIO can be accessed individually with the following user configurable features:

- Input/output direction
- Output drive strength
- Internal pull-up and pull-down resistors
- Wake-up from high-or low-level triggers on all pins
- Trigger interrupt on all pins
- All pin scan be used by the PPI task/event system; the maximum number of pins that can be interfaced through the PPI at the same time is limited by the number of GPIOTE channels
- All pins can be individually configured to carry serial interface or quadrature demodulator signals
- All pins can be configured as PWM



There are 4 ADC input in the 16 I/Os

Two-wire Interface (I2C Compatible)

The two-wire interface can communicate with a bi-directional wired-AND bus with two lines (SCL, SDA). The protocol makes it possible to interconnect up to 127 individually addressable devices. The interface is capable of clock stretching, supporting data rates of 100 kbps, 250 kbps and 400 kbps.

Flash Program I/Os

The module has two programmer pins, respectively SWDCLK pin and SWDIO pin. The two pin Serial Wire Debug (SWD) interface provided as a part of the Debug Access Port (DAP) offers a flexible and powerful mechanism for non-intrusive debugging of program code. Breakpoints and single stepping are part of this support.

Serial Peripheral Interface

The SPI interfaces enable full duplex synchronous communication between devices. They support a three- wire (SCK, MISO, and MOSI) bi-directional bus with fast data transfers. The SPI Master can communicate with multiple slaves using individual chip select signals for each of the slave devices attached to a bus. Control of chip select signals is left to the application through use of GPIO signals. SPI Master has double buffered I/O data. The SPI Slave includes Easy DMA for

data transfer directly to and from RAM allowing Slave data transfers to occur



while the CPU is IDLE. The GPIOs are used for each SPI interface line and can be chosen from any GPIOs on the device and configured independently. This enables great flexibility in device pinout and efficient use of printed circuit board space and signal routing.

The SPI peripheral supports SPI mode 0, 1, 2, and 3. The module has 3 SPI ports and their properties are as below:

| Instance | Master/Slave |
|----------|--------------|
| SPI0 | Master |
| SPI1 | Master |
| SPIS1 | Slave |

UARTs

The Universal Asynchronous Receiver/Transmitter offers fast, full-duplex, asynchronous serial communication with built-in flow control (CTS, RTS), support in hardware up to 1 Mbps baud. Parity checking is supported. Support the following baud rate in bps unit:

1200/2400/4800/9600/14400/19200/28800/38400/57600/76800/115200.

Note: The GPIOs are used for each SPI/TWI/UART interface line and can be chosen from any GPIOs on the device and configured independently.



Analogue to Digital Converter (ADC)

The 12-bit incremental Analogue to Digital Converter (ADC) enables sampling of up to 8 external signals through a front-end multiplexer. The ADC has configurable input and reference pre-scaling, and sample resolution (8, 10, and 12 bit).

| Module PIN Number | nRF52810 PINNumber | Description |
|-------------------------|-----------------------|---------------------|
| 3 | P0.28/AIN4 | General Purpose I/O |
| 4 | P0.30/AIN6 | General Purpose I/O |
| 13 | P0.04/AIN2 | General Purpose I/O |
| 14 | P0.05/AIN3 | General Purpose I/O |

Reset

There set pin of the module is in the internal pull-high state. When the reset pin of the module is input to a low level, the module will be automatically reset. After the reset pin is used, the parameters of the current setting will not be ANT.



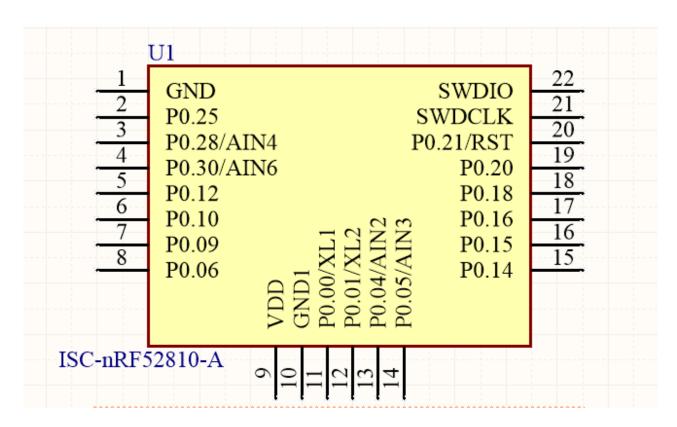
6. Module Specifications

| Hardware Features | |
|--------------------|-----------------------------|
| Model | ISC-nRF52810-A |
| Antenna Type | PCB Antenna |
| Chipset Solution | nRF52810 |
| Voltage | 1.7V~3.6V |
| Dimensions | |
| (L x W x H) | 18x12x2mm |
| Wireless Features | |
| Wireless Standards | BLE5.3,ANT |
| Frequency Range | 2400MHz-2483.5MHz |
| Data Rates | 1-2Mbps |
| Wireless Security | AES HW Encryption |
| Transmit Power | TxPower-20to+4dBmin4dBSteps |
| Operating Mode | Central/ Peripheral in BLE |



7. Module Pin-out and Pin Description

Schematic Symbol



PCB Footprint

Please contact ISC technical team for Altium SCH and PCB library or email to sales@indiesemic.com or nikul.shah@indiesemic.com



Pin Description

| Pin | Pin | nRF52810 | Pin Description | |
|-----|---------------|----------|--------------------------|--|
| No. | Name | MCUPin | | |
| 1 | GND | GND | GND | |
| 2 | P25 | P25 | General purpose I/O pin. | |
| 3 | P28/ | P28 | General purpose I/O pin. | |
| 3 | AIN4 | AIN4 | Analogue input | |
| 4 | P30/ | P30 | General purpose I/O pin | |
| | AIN6 | AIN6 | Analogue input | |
| 5 | P12 | P12 | General purpose I/O pin | |
| 6 | P10 | P10 | General purpose I/O pin | |
| 7 | P09 | P09 | General purpose I/O pin | |
| 8 | P06 | P06 | General purpose I/O pin | |
| 9 | P10 | VDD | PWR | |
| 10 | GND1 | GND1 | GND | |
| 11 | P0.00/ XL1 | P00 | General purpose I/O pin | |
| | ALI | XL1 | Reserved | |
| 12 | P0.01/ XL2 | P01 | General purpose I/O pin | |
| 12 | | XL2 | Reserved | |
| 13 | P04/ | P04 | General purpose I/O pin | |
| 10 | AIN2 | AIN2 | Analogue input | |
| 14 | P05/ | P05 | General purpose I/O pin | |
| 14 | AIN3 | AIN3 | Analogue input | |
| 15 | P14 | P14 | General purpose I/O pin | |
| 16 | P15 | P15 | General purpose I/O pin | |
| 17 | P16 | P16 | General purpose I/O pin | |





| 18 | P18 | P18 | General purpose I/O pin |
|----|--------|--------|---------------------------|
| 19 | P20 | P20 | General purpose I/O pin |
| 20 | P21/ | P21 | General purpose I/O pin |
| | RST | RST | Configurable as pin Reset |
| 21 | SWDCLK | SWDCLK | Programming clock |
| 22 | SWDIO | SWDIO | Programming Data |



8. Electrical Characteristics

Absolute Maximum Ratings

| Parameter | Condition | Min. | Typical | Max. | Unit |
|----------------|-----------|------|---------|------|------|
| Storage Temp. | | -40 | | 125 | °C |
| ESD Protection | | | | 4000 | V |
| Supply Voltage | | -0.3 | | 3.9 | V |
| Voltage on I/O | | -0.3 | | 3.6 | V |
| Pin | | | | | - |

8.2. Recommended Operating Ratings

| Parameter | Symbol | Min. | Typical | Max. | Unit |
|-----------------------|--------|---------|---------|---------|----------|
| Operating Temp. | TA | -40 | | 85 | °C |
| Power Supply | VCC | 1.7 | 3.3 | 3.6 | V |
| Input Low Voltage | VIL | -0.3 | | 0.3*VCC | V |
| Input High Voltage | VIH | 0.7*VCC | | VCC | \ |



8.3. Current Ratings

| System State | TX Peak @4dBm | RX Peak | Sleep Mode (Average) | Idle Mode (Average) |
|----------------------|------------------|---------|-------------------------|------------------------|
| Current (peak)@3V | 7.5mA | 10mA | 2.5uA | 2.5uA |



9. Ordering Information

| Module No | Shielding | Antenna |
|----------------|-----------|---------|
| ISC-nRF52840-A | No | PCB |